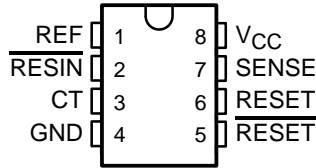


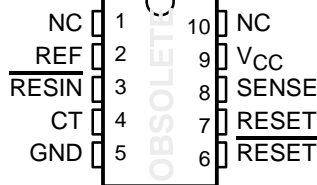
The TL7705BM is obsolete  
and no longer is supplied.

- Power-On Reset Generator
- Automatic Reset Generation After Voltage Drop
- $\overline{\text{RESET}}$  Output Defined From  $V_{CC} \geq 1 \text{ V}$
- Precision Voltage Sensor
- Temperature-Compensated Voltage Reference
- True and Complement Reset Outputs
- Externally Adjustable Pulse Duration

TL77xxBC ... D OR P PACKAGE  
TL7705BM ... JG PACKAGE  
TL7705BQ ... D PACKAGE  
(TOP VIEW)

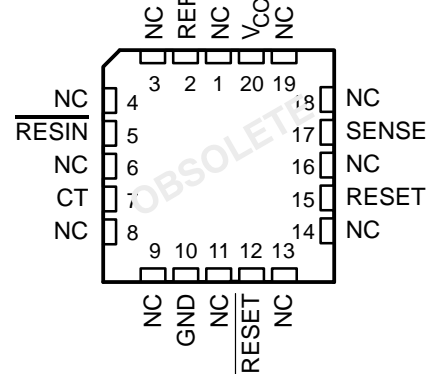


TL7705BM ... U PACKAGE  
(TOP VIEW)



NC – No internal connection

TL7705BM ... FK PACKAGE  
(TOP VIEW)



NC – No internal connection

## description/ordering information

The TL7702B, TL7705B, and TL7733B are integrated-circuit supply-voltage supervisors designed for use as reset controllers in microcomputer and microprocessor systems. The supply-voltage supervisor monitors the supply for undervoltage conditions at the SENSE input. During power up, the  $\overline{\text{RESET}}$  output becomes active (low) when  $V_{CC}$  attains a value approaching 1 V. As  $V_{CC}$  approaches 3 V (assuming that SENSE is above  $V_{T+}$ ), the delay-timer function activates a time delay, after which outputs  $\overline{\text{RESET}}$  and RESET go inactive (high and low, respectively). When an undervoltage condition occurs during normal operation, outputs  $\overline{\text{RESET}}$  and RESET go active. To ensure that a complete reset occurs, the reset outputs remain active for a time delay after the voltage at the SENSE input exceeds the positive-going threshold value. The time delay is determined by the value of the external capacitor  $C_T$ .  $t_d \approx 2.6 \times 10^4 \times C_T$ , where  $C_T$  is in farads (F) and  $t_d$  is in seconds (s).

An external capacitor (typically 0.1  $\mu\text{F}$ ) must be connected to REF to reduce the influence of fast transients in the supply voltage.

The TL7702BC, TL7705BC, and TL7733BC are characterized for operation from 0°C to 70°C. The TL7702BI, TL7705BI, and TL7733BI are characterized for operation from –40°C to 85°C. The TL7705BQ is characterized for operation from –40°C to 125°C. The TL7705BM is characterized for operation from –55°C to 125°C.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS  
INSTRUMENTS**

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On products compliant to MIL-PRF-38535, all parameters are tested unless otherwise noted. On all other products, production processing does not necessarily include testing of all parameters.

# TL7702B, TL7705B, TL7733B SUPPLY-VOLTAGE SUPERVISORS

The TL7705BM is obsolete  
and no longer is supplied.

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## description/ordering information (continued)

### ORDERING INFORMATION

TA	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
0°C to 70°C	PDIP (P)	Tube of 50	TL7702BCP	TL7702BCP
	SOIC (D)	Tube of 75	TL7702BCD	7702BC
		Reel of 2500	TL7702BCDR	
	PDIP (P)	Tube of 50	TL7705BCP	TL7705BCP
	SOIC (D)	Tube of 75	TL7705BCD	7705BC
		Reel of 2500	TL7705BCDR	
	PDIP (P)	Tube of 50	TL7733BCP	TL7733BCP
	SOIC (D)	Tube of 75	TL7733BCD	7733BC
		Reel of 2500	TL7733BCDR	
–40°C to 85°C	PDIP (P)	Tube of 50	TL7702BIP	TL7702BIP
	SOIC (D)	Tube of 75	TL7702BID	7702BI
		Reel of 2500	TL7702BIDR	
	PDIP (P)	Tube of 50	TL7705BIP	TL7705BIP
	SOIC (D)	Tube of 75	TL7705BID	7705BI
		Reel of 2500	TL7705BIDR	
	PDIP (P)	Tube of 50	TL7733BIP	TL7705BIP
	SOIC (D)	Tube of 75	TL7733BID	7733BI
		Reel of 2500	TL7733BIDR	
–40°C to 125°C	SOIC (D)	Tube of 75	TL7705BQD	TL7705BQD

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).



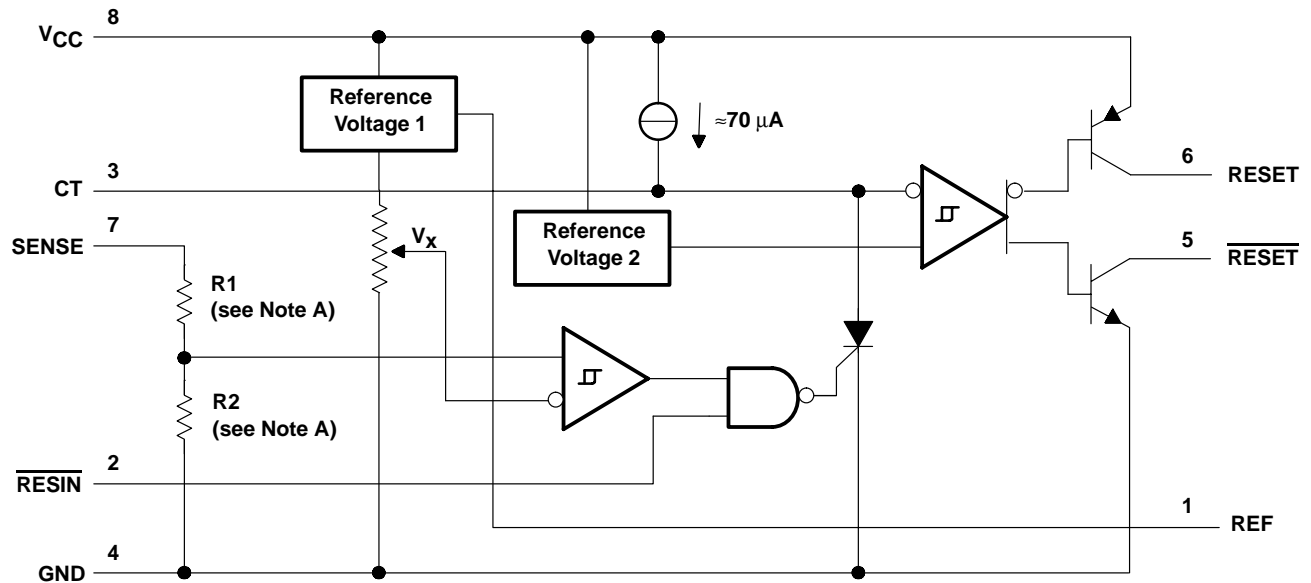
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The TL7705BM is obsolete  
and no longer is supplied.

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## functional block diagram

The functional block diagram is shown for illustrative purposes only; the actual circuit includes a trimming network to adjust the reference voltage and sense-comparator trip point.



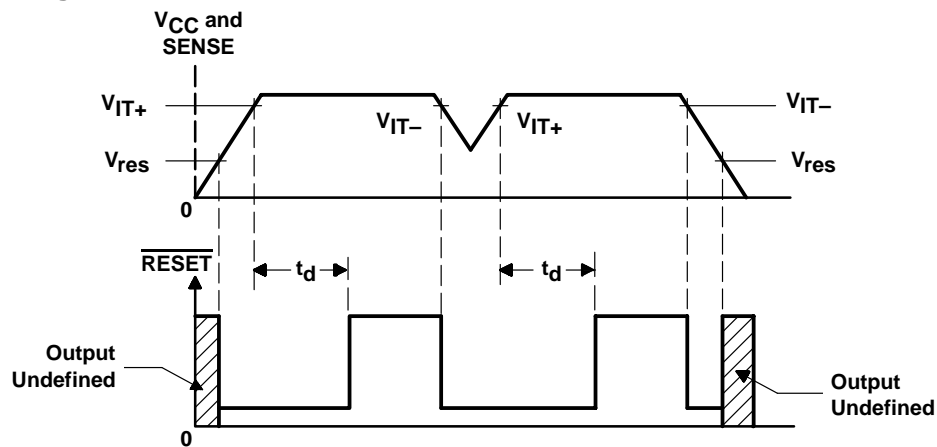
Pin numbers shown are for the D, JG, and P packages.

NOTE A: TL7702B: R1 = 0  $\Omega$ , R2 = open,  $V_x = V_{REF1}$

TL7705B: R1 = 23 k $\Omega$ , R2 = 10 k $\Omega$ , nominal,  $V_x \approx 1.43$  V

TL7733B: R1 = 11.3 k $\Omega$ , R2 = 10 k $\Omega$ , nominal,  $V_x \approx 1.43$  V

## typical timing diagram



# TL7702B, TL7705B, TL7733B SUPPLY-VOLTAGE SUPERVISORS

The TL7705BM is obsolete  
and no longer is supplied.

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## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage, $V_{CC}$ (see Note 1)	20 V
Input voltage range, $V_I$ : $\overline{\text{RESIN}}$	–0.3 V to 20 V
SENSE	–0.3 V to 20 V
High-level output current, $I_{OH}$ ( $\overline{\text{RESET}}$ )	–30 mA
Low-level output current, $I_{OL}$ ( $\overline{\text{RESET}}$ )	30 mA
Package thermal impedance, $\theta_{JA}$ (see Notes 2 and 3): D package	97°C/W
P package	85°C/W
Operating virtual junction temperature, $T_J$	150°C
Case temperature for 60 seconds, $T_C$ : FK package	260°C
Lead temperature 1,6 mm (1/16 inch) from case for 60 seconds: JG or U packages	300°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds: D or P packages	260°C
Storage temperature range, $T_{stg}$	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltage values are with respect to the network ground terminal.  
2. Maximum power dissipation is a function of  $T_J(\text{max})$ ,  $\theta_{JA}$ , and  $T_A$ . The maximum allowable power dissipation at any allowable ambient temperature is  $P_D = (T_J(\text{max}) - T_A)/\theta_{JA}$ . Operating at the absolute maximum  $T_J$  of 150°C can affect reliability.  
3. The package thermal impedance is calculated in accordance with JESD 51-7.

## recommended operating conditions

				MIN	MAX	UNIT
V <sub>CC</sub>	Supply voltage			3.6	18	V
V <sub>IH</sub>	High-level input voltage	RESIN		2	18	V
V <sub>IL</sub>	Low-level input voltage	RESIN		0	0.8	V
V <sub>I</sub>	Input voltage	SENSE		0	18	V
I <sub>OH</sub>	High-level output current	RESET			−20	mA
I <sub>OL</sub>	Low-level output current	RESET			20	mA
T <sub>A</sub>	Operating free-air temperature range	TL77xxBC		0	70	°C
		TL77xxBI		−40	85	
		TL7705BQ		−40	125	
		TL7705BM		−55	125	



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The TL7705BM is obsolete  
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electrical characteristics over recommended operating conditions (unless otherwise noted)

PARAMETER				TEST CONDITIONS†		TL77xxBC TL77xxBI TL7705BQ			UNIT	
						MIN	TYP	MAX		
V <sub>OH</sub>	High-level output voltage, RESET			I <sub>OH</sub> = −16 mA		V <sub>CC</sub> −1.5			V	
V <sub>OL</sub>	Low-level output voltage, RESET			I <sub>OL</sub> = 16 mA		0.4			V	
V <sub>ref</sub>	Reference voltage, REF			I <sub>ref</sub> = −500 μA, T <sub>A</sub> = 25°C		2.48	2.53	2.58	V	
V <sub>IT−</sub>	Negative-going input threshold voltage at SENSE input		TL7702B	T <sub>A</sub> = 25°C		2.505	2.53	2.555	V	
			TL7705B			4.5	4.55	4.6		
			TL7733B			3.03	3.08	3.13		
			TL7702B	T <sub>A</sub> = full range‡		2.48	2.53	2.58		
			TL7705B			4.45	4.55	4.65		
			TL7733B			3	3.08	3.16		
V <sub>hys</sub>	Hysteresis, SENSE (V <sub>IT+</sub> − V <sub>IT−</sub> )		TL7702B	V <sub>CC</sub> = 3.6 V to 18 V, T <sub>A</sub> = 25°C		10			mV	
			TL7705B			30				
			TL7733B			10				
V <sub>res</sub> §	Power-up reset voltage			I <sub>OL</sub> at RESET = 2 mA, T <sub>A</sub> = 25°C		1			V	
I <sub>I</sub>	Input current		RESIN		V <sub>I</sub> = 0.4 V to V <sub>CC</sub>		−10			μA
			SENSE	TL7702B	V <sub>I</sub> = V <sub>ref</sub> to 18 V		−0.1 −2			
I <sub>OH</sub>	High-level output current, RESET			V <sub>O</sub> = 18 V, See Figure 1		50			μA	
I <sub>OL</sub>	Low-level output current, RESET			V <sub>O</sub> = 0 V, See Figure 1		−50			μA	
I <sub>CC</sub>	Supply current			V <sub>SENSE</sub> = 15 V, RESIN ≥ 2 V		1.8 3			mA	
				V <sub>CC</sub> = 18 V, T <sub>A</sub> = full range‡		3.5				

† All electrical characteristics are measured with 0.1-µF capacitors connected at REF, CT, and V<sub>CC</sub> to GND.

‡ Full range is 0°C to 70°C for the C-suffix devices, −40°C to 85°C for the I-suffix devices, and −40°C to 125°C for the Q-suffix device.

§ This is the lowest voltage at which RESET becomes active.

switching characteristics, V<sub>CC</sub> = 5 V, C<sub>T</sub> open, T<sub>A</sub> = 25°C

PARAMETER		FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	TL77xxBC TL77xxBI TL7705BQ			UNIT
					MIN	TYP	MAX	
t <sub>PLH</sub>	Propagation delay time from low- to high-level output	RESIN	RESET	See Figures 1, 2, and 3		270	500	ns
t <sub>PHL</sub>	Propagation delay time from high- to low-level output	RESIN	RESET	See Figures 1, 2, and 3		270	500	ns
t <sub>w</sub>	Effective pulse duration	RESIN		See Figure 2		150		ns
		SENSE				100		
t <sub>r</sub>	Rise time		RESET	See Figures 1 and 3			75	ns
t <sub>f</sub>	Fall time					150	200	
t <sub>r</sub>	Rise time		RESET	See Figures 1 and 3			75	ns
t <sub>f</sub>	Fall time						50	

# TL7702B, TL7705B, TL7733B SUPPLY-VOLTAGE SUPERVISORS

The TL7705BM is obsolete  
and no longer is supplied.

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## electrical characteristics over recommended operating conditions (unless otherwise noted)

PARAMETER				TEST CONDITION†	TL7705BM			UNIT
					MIN	TYP	MAX	
V <sub>OH</sub>	High-level output voltage, RESET			I <sub>OH</sub> = −16 mA	V <sub>CC</sub> −1.5			V
V <sub>OL</sub>	Low-level output voltage, RESET			I <sub>OL</sub> = 16 mA	0.4			V
V <sub>ref</sub>	Reference voltage, REF			I <sub>ref</sub> = −500 μA,      T <sub>A</sub> = 25°C	2.48	2.53	2.58	V
V <sub>IT−</sub>	Negative-going input threshold voltage at SENSE input	TL7702B		T <sub>A</sub> = 25°C	2.505	2.53	2.555	V
		TL7705B			4.5	4.55	4.6	
		TL7702B		T <sub>A</sub> = −55°C to 125°C	2.48	2.53	2.58	
		TL7705B			4.45	4.55	4.65	
V <sub>hys</sub>	Hysteresis, SENSE (V <sub>IT+</sub> − V <sub>IT−</sub> )	TL7702B		V <sub>CC</sub> = 3.6 V to 18 V,      T <sub>A</sub> = 25°C	10			mV
		TL7705B			30			
V <sub>res</sub> ‡	Power-up reset voltage			I <sub>OL</sub> at RESET = 2 mA,      T <sub>A</sub> = 25°C	1			V
I <sub>I</sub>	Input current	RESIN		V <sub>I</sub> = 0.4 V to V <sub>CC</sub>	−10			μA
		SENSE	TL7702B	V <sub>I</sub> = V <sub>ref</sub> to V <sub>CC</sub> − 1.5 V	−0.1      −2			
I <sub>OH</sub>	High-level output current, RESET			V <sub>O</sub> = 18 V	50			μA
I <sub>OL</sub>	Low-level output current, RESET			V <sub>O</sub> = 0	−50			μA
I <sub>CC</sub>	Supply current			V <sub>SENSE</sub> = 15 V,      RESIN ≥ 2 V	1.8		3	mA
				V <sub>CC</sub> = 18 V,      T <sub>A</sub> = −55°C to 125°C	4			

† All electrical characteristics are measured with 0.1-µF capacitors connected at REF, CT, and V<sub>CC</sub> to GND.

‡ This is the lowest value at which RESET becomes active.

## switching characteristics, V<sub>CC</sub> = 5 V, C<sub>T</sub> open, T<sub>A</sub> = 25°C

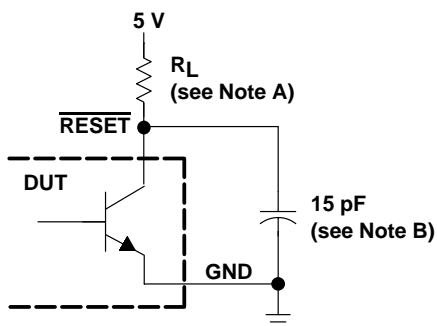
PARAMETER		FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	TL7705BM			UNIT
					MIN	TYP	MAX	
t <sub>PLH</sub>	Propagation delay time from low- to high-level output	RESIN	RESET	See Figures 1, 2, and 3		270	500*	ns
t <sub>PHL</sub>	Propagation delay time from high- to low-level output	RESIN	RESET	See Figures 1, 2, and 3		270	500*	ns
t <sub>w</sub>	Effective pulse duration	RESIN		See Figure 2		150		ns
		SENSE				100		
t <sub>r</sub>	Rise time		RESET	See Figures 1 and 3			75*	ns
t <sub>f</sub>	Fall time					150	200*	
t <sub>r</sub>	Rise time		RESET	See Figures 1 and 3		75	150*	ns
t <sub>f</sub>	Fall time						50*	

\* On products compliant to MIL-PRF-38535, these parameters are not production tested.

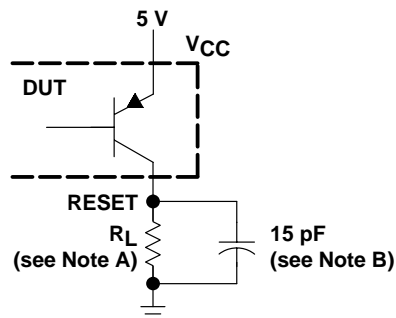


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## PARAMETER MEASUREMENT INFORMATION



$\overline{\text{RESET}}$  OUTPUT CONFIGURATION



RESET OUTPUT CONFIGURATION

NOTES: A. For  $I_{OL}$  and  $I_{OH}$ ,  $R_L = 10 \text{ k}\Omega$ . For all switching characteristics,  $R_L = 511 \Omega$ .  
B. This figure includes jig and probe capacitance.

Figure 1. RESET and  $\overline{\text{RESET}}$  Output Configurations



WAVEFORMS

Figure 2. Input Pulse Definition

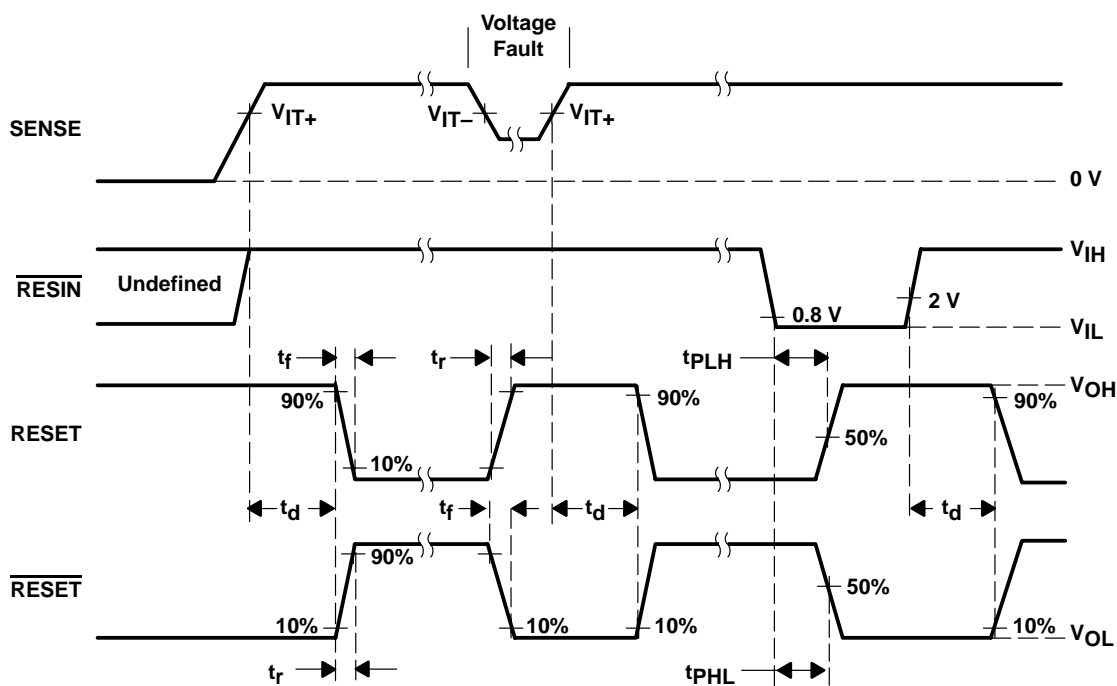


Figure 3. Voltage Waveforms

# TYPICAL CHARACTERISTICS†

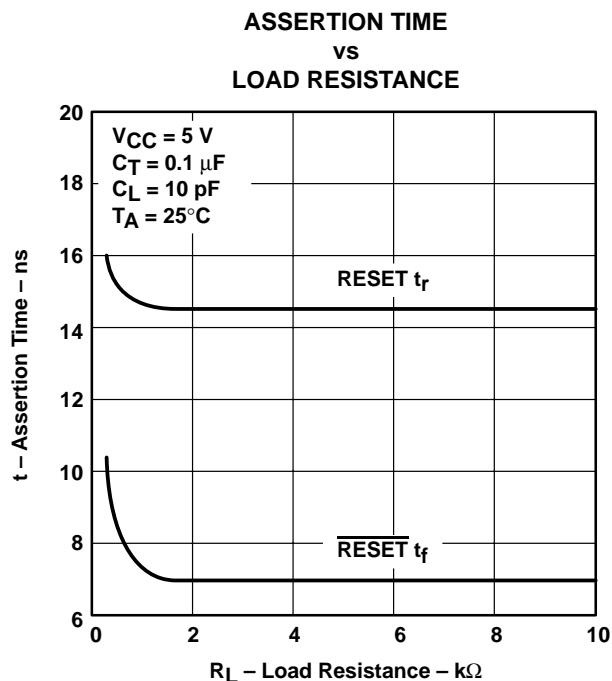


Figure 4

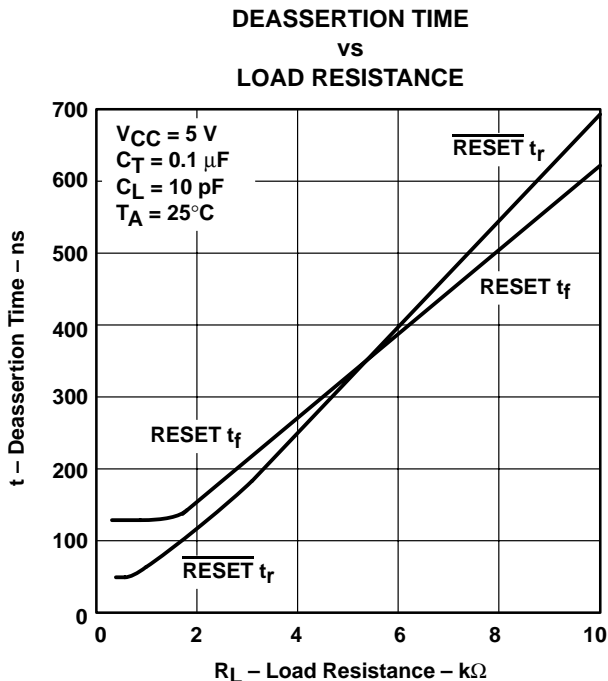


Figure 5

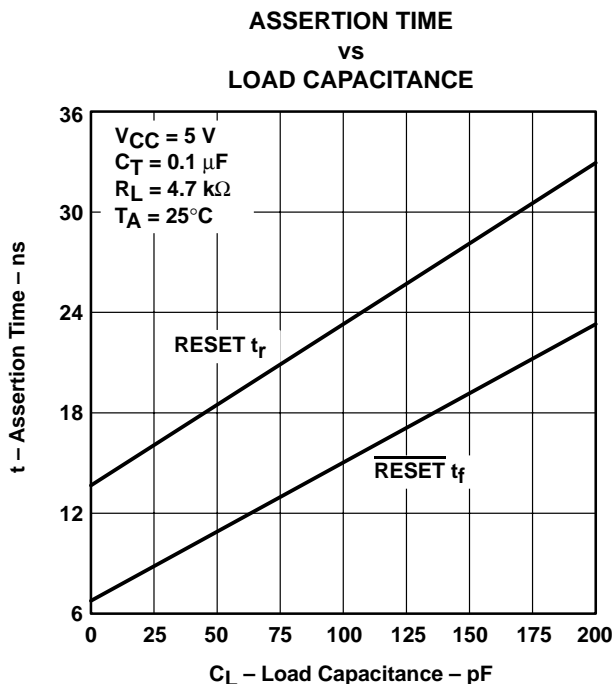


Figure 6

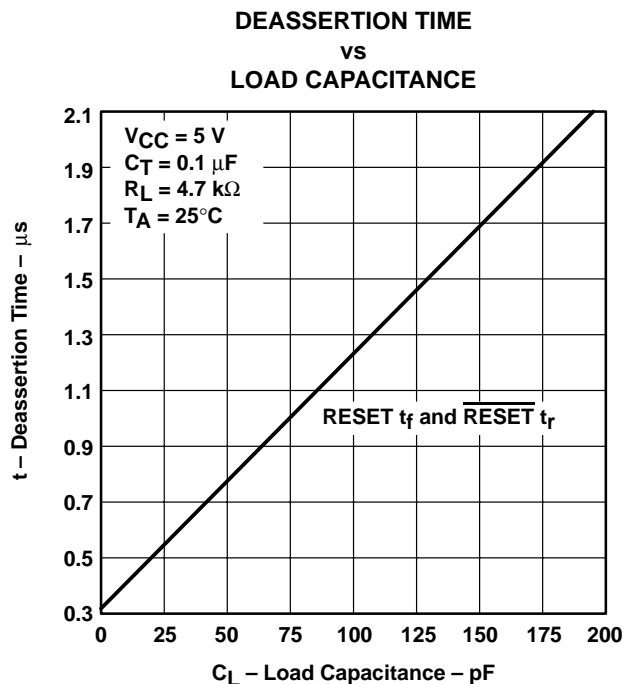
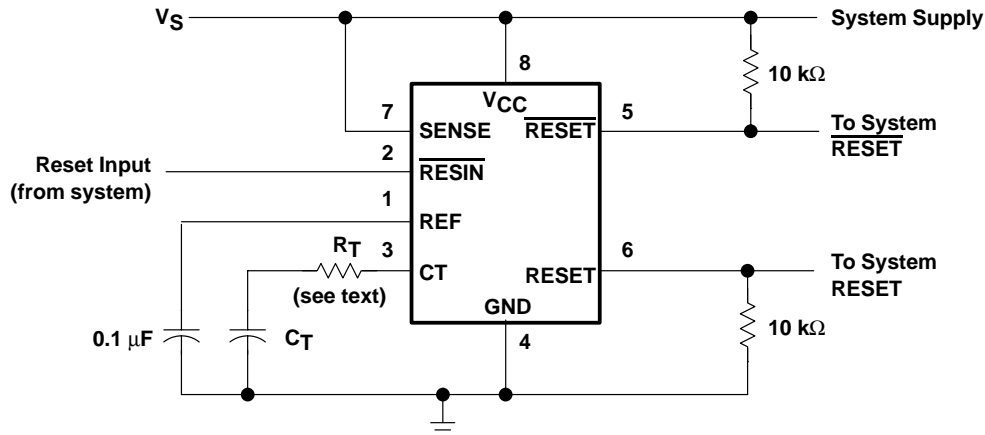


Figure 7

† For proper operation, both RESET and  $\overline{\text{RESET}}$  should be terminated with resistors of similar value. Failure to do so may cause unwanted plateauing in either output waveform during switching.



## APPLICATION INFORMATION



**Figure 8. System Reset Controller With Undervoltage Sensing**

When the TL770xB SENSE terminal is used to monitor  $V_{CC}$ , a current-limiting resistor in series with  $C_T$  is recommended. During normal operation, the timing capacitor is charged by the onboard current source to approximately  $V_{CC}$  or an internal voltage clamp ( $\approx 7.1$ -V Zener), whichever is less. When the circuit then is subjected to an undervoltage condition during which  $V_{CC}$  is rapidly slewed down, the voltage on CT exceeds that on  $V_{CC}$ . This forward biases a secondary path internally, which falsely activates the outputs. A fault is indicated when  $V_{CC}$  drops below  $V_{(CT)}$ , not when  $V_{SENSE}$  falls below  $V_{T-}$ .

Texas Instruments performs a 100% electrical screen to verify that the outputs do not switch with 1 mA forced into the CT terminal. Adding the external resistor,  $R_T$ , prevents false triggering. Its value is calculated as follows:

$$\frac{V_{(CT)} - V_{T-}}{R_T}$$

Where:

$$\begin{aligned} V_{(CT)} &= V_{CC} \text{ or } 7.1 \text{ V, whichever is less} \\ V_{T-} &= 4.55 \text{ V (nom)} \\ R_T &= \text{value of series resistor required} \end{aligned}$$

For  $V_{CC} = 5 \text{ V}$ :

$$\frac{5 - 4.55}{R_T} < 1 \text{ mA}$$

Therefore,

$$R_T > 450 \text{ } \Omega$$

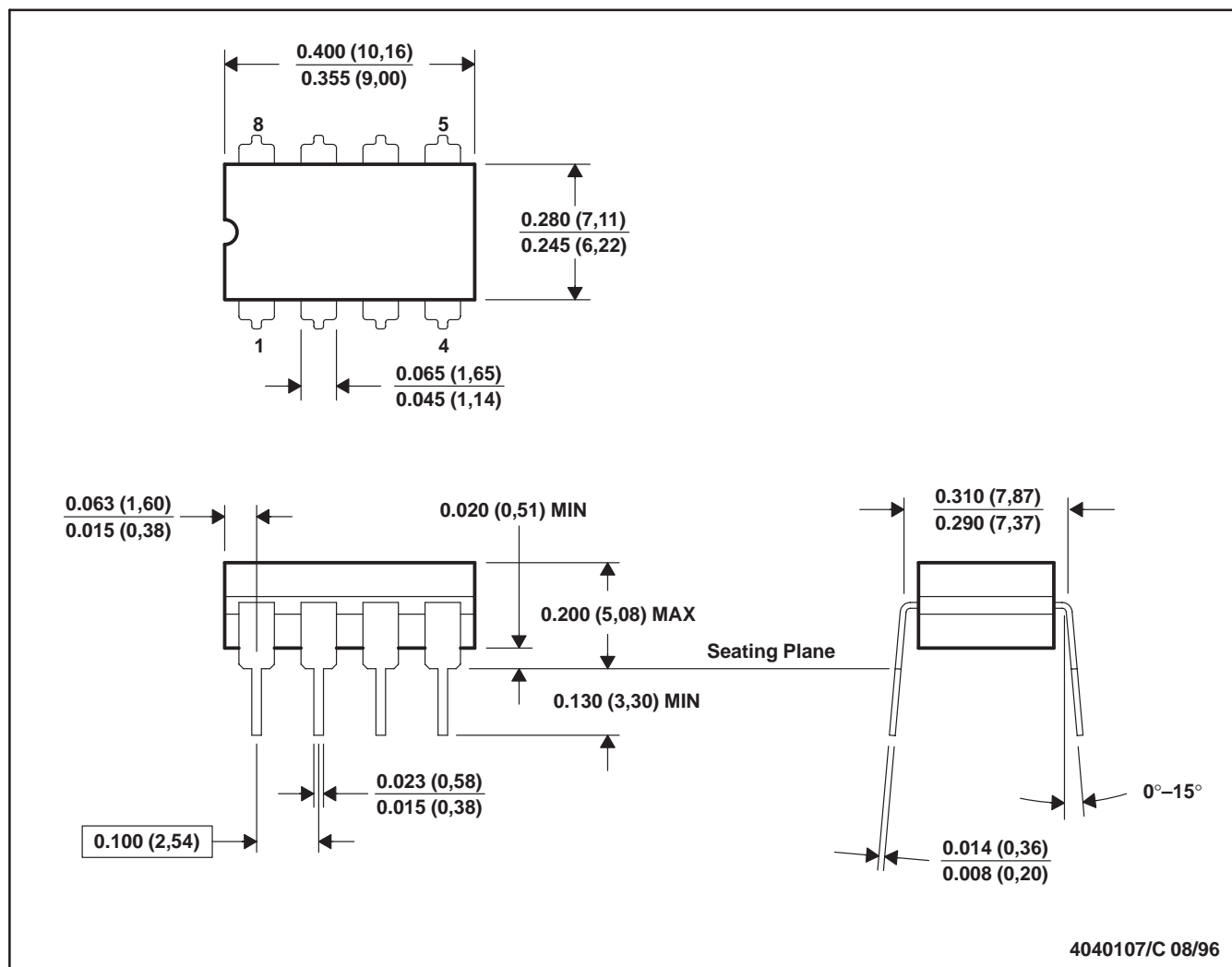
Using a 20%-tolerance resistor,  $R_T$  should be greater than 560  $\Omega$ .

Adding this series resistor changes the duration of the reset pulse by no more than 10%.  $R_T$  extends the discharge of  $C_T$ , but also skews the  $V_{(CT)}$  threshold. These effects tend to cancel one another. The precise percentage change can be derived theoretically, but the equation is complicated by this interaction and is dependent upon the duration of the supply-voltage fault condition.

Both outputs of the TL770xB should be terminated with similar value resistors, even when only one is being used. This prevents unwanted plateauing in either output waveform during switching, which may be interpreted as an undefined state or delay system reset.

## JG (R-GDIP-T8)

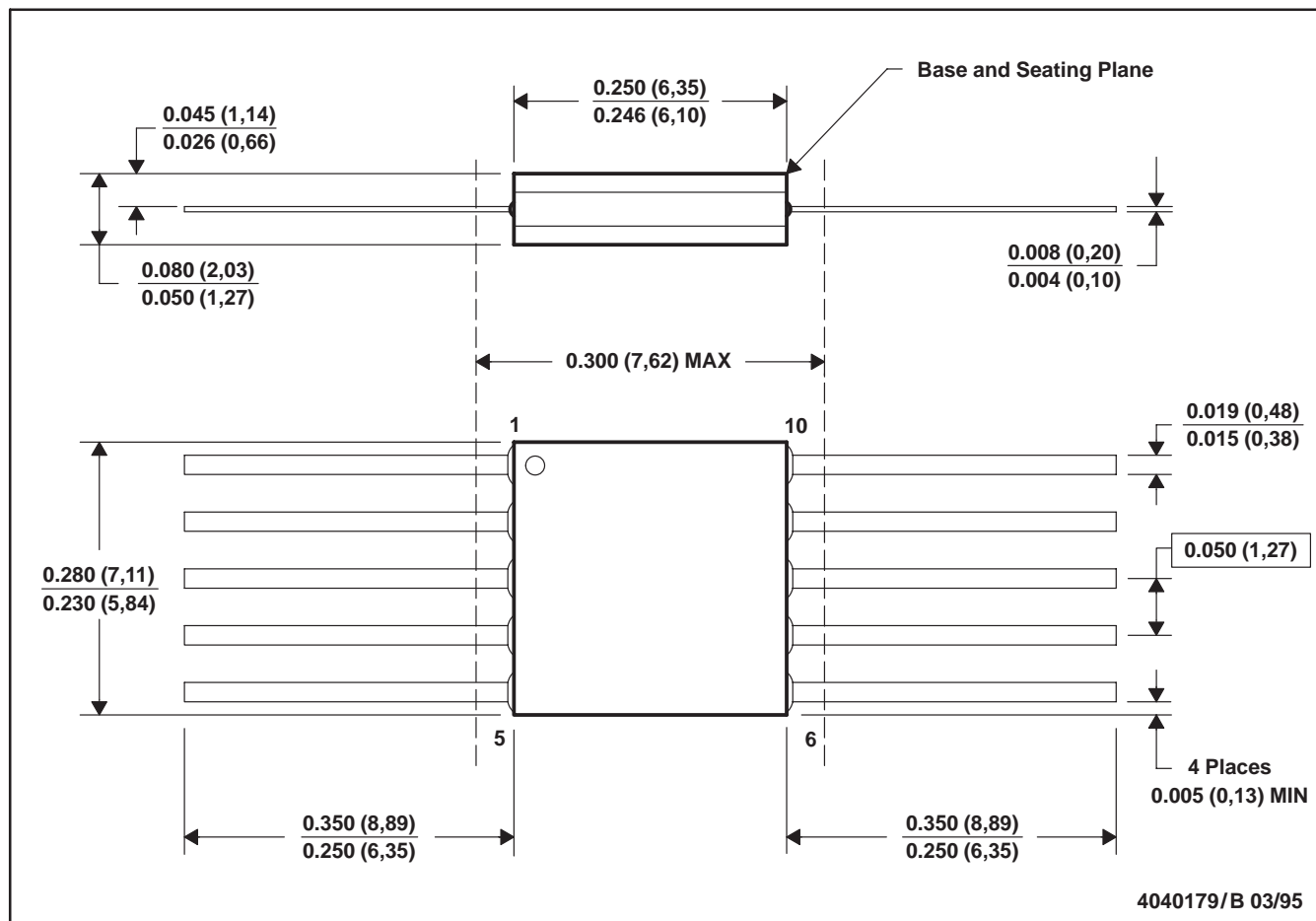
## CERAMIC DUAL-IN-LINE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package can be hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification.
  - E. Falls within MIL STD 1835 GDIP1-T8

## U (S-GDFP-F10)

## CERAMIC DUAL FLATPACK



- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. This package can be hermetically sealed with a ceramic lid using glass frit.  
 D. Index point is provided on cap for terminal identification only.  
 E. Falls within MIL STD 1835 GDFP1-F10 and JEDEC MO-092AA

## FK (S-CQCC-N\*\*)

## LEADLESS CERAMIC CHIP CARRIER

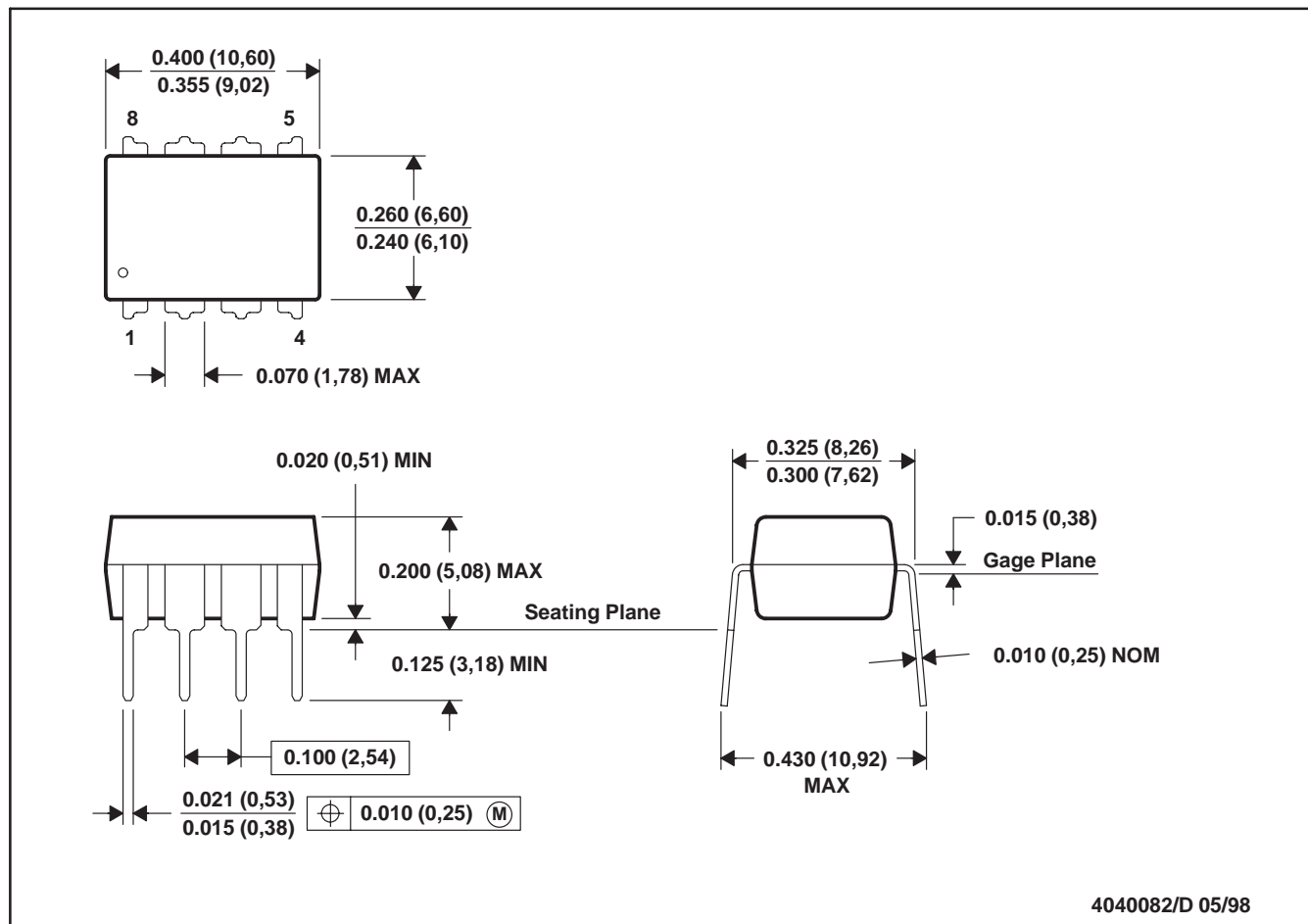
28 TERMINAL SHOWN



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package can be hermetically sealed with a metal lid.
  - D. The terminals are gold plated.
  - E. Falls within JEDEC MS-004

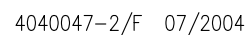
## P (R-PDIP-T8)

## PLASTIC DUAL-IN-LINE



- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. Falls within JEDEC MS-001

For the latest package information, go to [http://www.ti.com/sc/docs/package/pkg\\_info.htm](http://www.ti.com/sc/docs/package/pkg_info.htm)



A. All linear dimensions are in inches (millimeters).  
B. This drawing is subject to change without notice.  
C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).  
D. Falls within JEDEC MS-012 variation AA.

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